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TLP3122

1. Applications

- · Measuring Instruments
- · High-Speed Logic IC Testers
- · High-Speed Memory Testers
- · Board Testers
- · Factory Automation (FA)

2. General

The TOSHIBA TLP3122 consists of a gallium arsenide infrared emitting diode optically coupled to a photo-MOS FET in a plastic SOP package.

The TLP3122 is a bi-directional switch, which can replace mechanical relays in many applications. And its high on-state current maximum rating is suitable to control a power line.

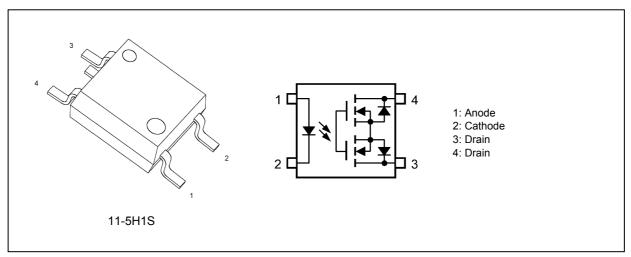
3. Features

- (1) Package: SOP (2.54SOP4) (Height 2.1 mm, pitch 2.54 mm)
- (2) Normally opened (1-Form-A)
- (3) OFF-state output terminal voltage: 60 V (min)
- (4) Trigger LED current: 3 mA (max)
- (5) ON-state current: 1 A (max) ($T_a = 25$ °C)
- (6) ON-state resistance: 0.7Ω (max)
- (7) Off-state capacitance: 90 pF (typ.)
- (8) Off-state current: 100 nA (max)
- (9) Isolation voltage: 1500 Vrms (min)
- (10) safety standards

UL-approved: UL1577, File No.E67349

cUL-approved: CSA Component Acceptance Service No.5A File No.E67349

4. Packaging and Pin Assignment

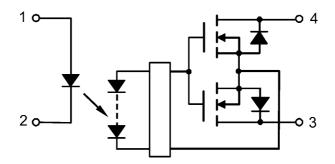


Start of commercial production

2004-06



5. Internal Circuit



6. Absolute Maximum Ratings (Note) (Unless otherwise specified, Ta = 25 °C)

	Characteristic	Symbol	Note	Rating	Unit	
LED	Input forward current		I _F		50	mA
	Input forward current derating	$(T_a \ge 25 ^{\circ}C)$	$\Delta I_F/\Delta T_a$		-0.5	mA/°C
	Input forward current (pulsed)	(100 μs pulse, 100 pps)	I _{FP}		1	Α
	Input reverse voltage		V_R		5	V
	Input power dissipation		P_{D}		50	mW
	Input power dissipation derating	$(T_a \ge 25 ^{\circ}C)$	$\Delta P_D/\Delta T_a$		-0.5	mW/°C
	Junction temperature		Tj		125	°C
Detector	OFF-state output terminal voltage		V _{OFF}		60	V
	ON-state current		I _{ON}		1	Α
	ON-state current derating	(T _a ≥ 50 °C)	Δl _{ON} /ΔT _a		-13.3	mA/°C
	ON-state current (pulsed)	(t = 100 ms)	I _{ONP}		3	Α
	Output power dissipation		Po		500	mW
	Output power dissipation derating	(T _a ≥ 50 °C)	$\Delta P_{O}/\Delta T_{a}$		-6.7	mW/°C
	Junction temperature		Tj		125	°C
Common	Storage temperature		T _{stg}		-40 to 125	°C
	Operating temperature		T _{opr}		-40 to 85	
	Lead soldering temperature	(10 s)	T _{sol}		260	°C
	Isolation voltage	AC, 60 s, R.H. ≤ 60 %	BV _S	(Note 1)	1500	Vrms

Note: Using continuously under heavy loads (e.g. the application of high temperature/current/voltage and the significant change in temperature, etc.) may cause this product to decrease in the reliability significantly even if the operating conditions (i.e. operating temperature/current/voltage, etc.) are within the absolute maximum ratings.

Please design the appropriate reliability upon reviewing the Toshiba Semiconductor Reliability Handbook ("Handling Precautions"/"Derating Concept and Methods") and individual reliability data (i.e. reliability test report and estimated failure rate, etc).

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

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7. Recommended Operating Conditions (Note)

Characteristics	Symbol	Note	Min	Тур.	Max	Unit
Supply voltage	V_{DD}		_	_	48	V
Input forward current	I _F		5	10	25	mA
ON-state current	I _{ON}		_	_	1	Α
Operating temperature	T _{opr}		-20		65	°C

Note: The recommended operating conditions are given as a design guide necessary to obtain the intended performance of the device. Each parameter is an independent value. When creating a system design using this device, the electrical characteristics specified in this data sheet should also be considered.

8. Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

	Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
LED	Input forward voltage	V _F		I _F = 10 mA	1.0	1.15	1.3	V
	Input reverse current	I _R		V _R = 5 V			10	μΑ
	Input capacitance	Ct		V = 0 V, f = 1 MHz	_	15		pF
Detector	OFF-state current	I _{OFF}		V _{OFF} = 60 V	_	0.2	100	nA
	Output capacitance	C _{OFF}	·	V = 0 V, f = 1 MHz	_	90		pF

9. Coupled Electrical Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Trigger LED current	I _{FT}		I _{ON} = 100 mA	_	1	3	mA
Return LED current	I _{FC}		I _{OFF} = 100 μA	0.1	0.8		mA
ON-state resistance	R _{ON}		I _{ON} = 1 A, I _F = 5 mA, t < 1 s	_	0.25	0.7	Ω

10. Isolation Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Total capacitance (input to output)	C _S	(Note 1)	V _S = 0 V, f = 1 MHz		0.8		pF
Isolation resistance	R _S	(Note 1)	V _S = 500 V, R.H. ≤ 60 %	5 × 10 ¹⁰	1014		Ω
Isolation voltage	BVS	(Note 1)	AC, 60 s	1500		_	Vrms
			AC, 1 s in oil		3000	_	
			DC, 60 s in oil		3000		Vdc

Note 1: This device is considered as a two-terminal device: Pins 1 and 2 are shorted together, and pins 3 and 4 are shorted together.

Rev.4.0



11. Switching Characteristics (Unless otherwise specified, T_a = 25 °C)

Characteristics	Symbol	Note	Test Condition	Min	Тур.	Max	Unit
Turn-on time	t _{ON}		See Fig. 11.1. $R_L = 200 \Omega$, $V_{DD} = 20 V$, $I_F = 5 mA$	1	1.4	3	ms
Turn-off time	t _{OFF}		See Fig. 11.1. R _L = 200 Ω , V _{DD} = 20 V, I _F = 5 mA	_	0.6	1	ms

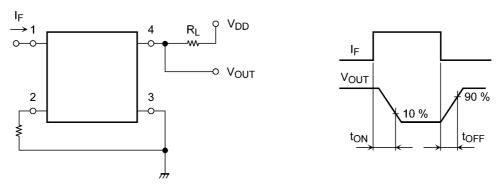


Fig. 11.1 Switching Time Test Circuit and Waveform



12. Characteristics Curves (Note)

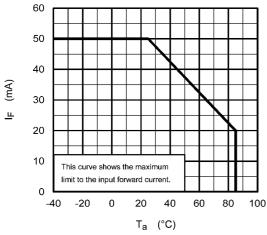


Fig. 12.1 I_F - T_a

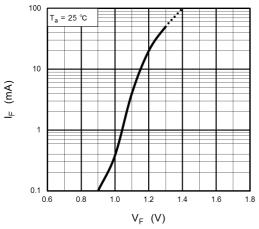


Fig. 12.3 I_F - V_F

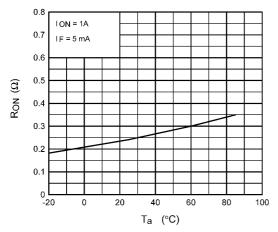


Fig. 12.5 R_{ON} - T_a

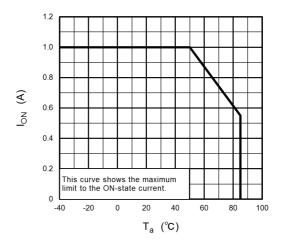


Fig. 12.2 I_{ON} - T_a

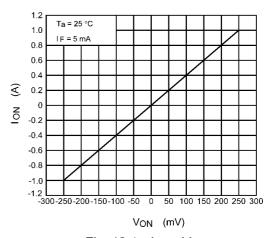


Fig. 12.4 I_{ON} - V_{ON}

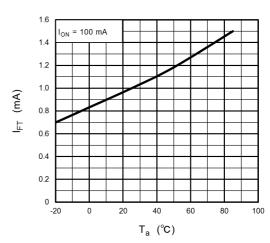


Fig. 12.6 I_{FT} - T_a



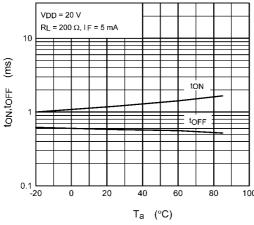


Fig. 12.7 ton,toff - Ta

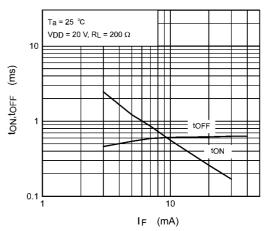


Fig. 12.8 ton,toff - If

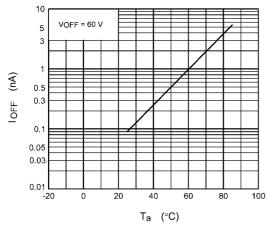


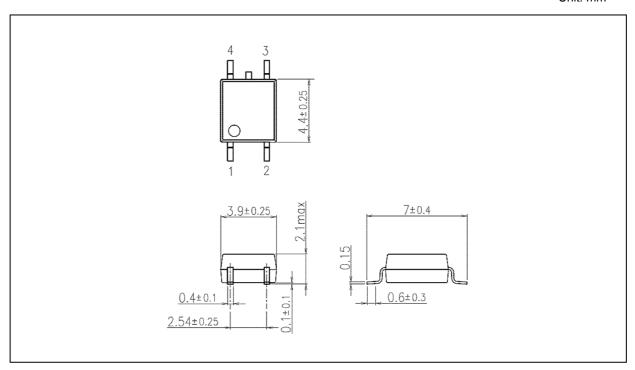
Fig. 12.9 I_{OFF} - T_a

Note: The above characteristics curves are presented for reference only and not guaranteed by production test, unless otherwise noted.



Package Dimensions

Unit: mm



Weight: 0.1 g (typ.)

	Package Name(s)
TOSHIBA: 11-5H1S	



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